

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	0	"Alq3" with resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 11:42
L3	0	"Alq3" with ohm	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 11:42
L4	0	"Alq.sub.3" with ohm	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 11:42
L5	0	"quinolinolato"\$4 with resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/10 11:43
L6	0	"quinolinolato"\$4 with (specific adj resistance resistivity)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/10 11:43
L7	3	"Alq.sub.3" with (specific adj resistance resistivity)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/10 11:51
L8	1	"6774561".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/10 11:51
L9	1	8 and (conductivity option\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/10 11:51
L10	1	"6831408".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/10 12:27

L11	2	10 l8	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/10 12:27
L12	2	11 and laminate	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/10 12:28
L13	1	"20040189186".did.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/10 12:29
L14	1	13 and laminate	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/10 12:34
L15	2	11 and alloy	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/10 12:34
L16	2	11 and (blend\$5 mix mixed mixture highly adj dispersed dispersed knead\$4 admix\$6 scatter\$4)	US-PGPUB; USPAT	OR	ON	2005/06/10 14:15
L17	174	sony.as. and organic and laminate	US-PGPUB; USPAT	OR	ON	2005/06/10 12:39
L18	98	sony.as. and organic and laminate and alloy	US-PGPUB; USPAT	OR	ON	2005/06/10 12:40
L19	23	sony.as. and organic and laminate and alloy and display	US-PGPUB; USPAT	OR	ON	2005/06/10 12:40
L20	23	19 and alloy.bi.	US-PGPUB; USPAT	OR	ON	2005/06/10 12:43
L21	873	(313/503).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/06/10 12:47
L22	177	21 and alloy same oxide	US-PGPUB; USPAT	OR	ON	2005/06/10 12:44
L23	3	21 and alloy same oxide same (chromium cr) same (niobium nb)	US-PGPUB; USPAT	OR	ON	2005/06/10 12:47
L24	3062	(313/503,504).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/10 13:17

L25	8	24 and alloy same oxide same (chromium cr) same (niobium nb) same tungsten	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 13:18
L26	2	"6885147".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 13:14
L27	2	26 and (multilayer multi)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 13:14
L28	5548	(313/503-512).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/10 13:31
L29	9	28 and alloy same oxide same (chromium cr) same (niobium nb) same tungsten	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 13:18
L30	1	28 and alloy same oxide same (chromium cr) same (niobium nb) same tungsten not l25	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 13:19
L31	0	bierelein.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 13:19
L32	0	bierelein.in. and anode adj modification adj layer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 13:19

L33	8	anode adj modification adj layer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 13:20
L34	1	("2002/0117962").URPN.	USPAT	OR	OFF	2005/06/10 13:27
L35	413	28 and ((plural double triple multi dual) adj (coat\$5 layer\$5 jacket\$5 film skin plating plated sublayer sub adj layer lamina\$5 overcoat\$4 monolayer\$4) (multicoat\$5 multilayer\$5 multijacket\$5 multifilm multiskin multiplating multiplated multisublayer multisub adj layer multilamina\$5 multiovercoat\$4) bilayer trilayer) near5 (anode cathode electrode)	US-PGPUB; USPAT	OR	OFF	2005/06/10 13:32
L36	20	28 and ((plural double triple multi dual) adj (coat\$5 layer\$5 jacket\$5 film skin plating plated sublayer sub adj layer lamina\$5 overcoat\$4 monolayer\$4) (multicoat\$5 multilayer\$5 multijacket\$5 multifilm multiskin multiplating multiplated multisublayer multisub adj layer multilamina\$5 multiovercoat\$4) bilayer trilayer) near5 (anode cathode electrode) same oxide same alloy	US-PGPUB; USPAT	OR	OFF	2005/06/10 13:36
L37	1	"6831408".pn.	US-PGPUB; USPAT	OR	OFF	2005/06/10 13:36
L38	1	37 and oxide near5 (metallic metal)	US-PGPUB; USPAT	OR	OFF	2005/06/10 13:37
L39	1	37 and oxide	US-PGPUB; USPAT	OR	OFF	2005/06/10 13:40
L40	1	"6774561".pn.	US-PGPUB; USPAT	OR	OFF	2005/06/10 13:40
L41	1	"6774561".PN.	DERWENT	OR	ON	2005/06/10 14:17
L42	1	2002-500914.NRAN.	DERWENT	OR	OFF	2005/06/10 14:15
L43	0	"WO-200134382-\$.did"	DERWENT	OR	ON	2005/06/10 14:17
L44	0	"WO-2002056641-\$.did"	DERWENT	OR	ON	2005/06/10 14:17
L45	0	"WO-200256641-\$.did"	DERWENT	OR	ON	2005/06/10 15:02
L46	1	2002-500914.NRAN.	DERWENT	OR	OFF	2005/06/10 14:18
L47	1	"6831408"	USPAT	OR	ON	2005/06/10 15:02
L48	0	47 AND "CrO.sub.2"	USPAT	OR	ON	2005/06/10 15:02
S1	1	"20040189186".did.	US-PGPUB; USPAT	OR	OFF	2005/06/09 13:32

S2	2405	(313/504).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/08 17:29
S3	2405	(313/504).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/08 19:14
S4	288	S3 and plasma near3 (treatment treated treating)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 17:29
S5	111	S3 and plasma near3 (treatment treated treating) with (electrode cathode anode)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 18:05
S6	7	S3 and plasma near3 (treatment treated treating) with forming with (electrode cathode anode)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 17:33
S8	1	"20040189186".did.	US-PGPUB; USPAT	OR	OFF	2005/06/08 17:41
S9	1	S8 and laminate	US-PGPUB; USPAT	OR	OFF	2005/06/08 17:41
S10	75	S3 and plasma near3 (treatment treated treating) with (electrode cathode anode) same (oxygen ozone "O.sub.2" "O.sub.3")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 18:06
S11	7	S3 and plasma near3 (treatment treated treating) with (electrode cathode anode) same (oxygen ozone "O.sub.2" "O.sub.3") and resistivity and reflect\$6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 18:08

S12	4	(BOLED OLED OEL TOLED SOLED FOLED PLED (polymer organic) near2 (EL adj (apparatus device) light lamp luminaire electroluminesc\$9 electro adj luminesc\$9 EL ELD) OELD OED LESD) and plasma near3 (treatment treated treating).ab,ti, clm. with (electrode cathode anode) same (oxygen ozone "O.sub.2" "O.sub.3") and resistivity and reflect\$6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 18:08
S13	8	(BOLED OLED OEL TOLED SOLED FOLED PLED (polymer organic) near2 (EL adj (apparatus device) light lamp luminaire electroluminesc\$9 electro adj luminesc\$9 EL ELD) OELD OED LESD).ab,ti,clm. and plasma near3 (treatment treated treating) with (electrode cathode anode) same (oxygen ozone "O.sub.2" "O.sub.3") and resistivity and reflect\$6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 18:22
S14	34	(BOLED OLED OEL TOLED SOLED FOLED PLED (polymer organic) near2 (EL adj (apparatus device) light lamp luminaire electroluminesc\$9 electro adj luminesc\$9 EL ELD) OELD OED LESD).ab,ti,clm. and plasma near3 (treatment treated treating) with (electrode cathode anode) same (oxygen ozone "O.sub.2" "O.sub.3") and (resistivity resistance) and reflect\$6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 19:10
S15	47	(BOLED OLED OEL TOLED SOLED FOLED PLED (polymer organic) near2 (EL adj (apparatus device) light lamp luminaire electroluminesc\$9 electro adj luminesc\$9 EL ELD) OELD OED LESD).ab,ti,clm. and plasma near3 (treatment treated treating) with (electrode cathode anode) same (oxygen ozone "O.sub.2" "O.sub.3") and (resistivity resistance) and (tungsten nickel chromium manganese indium tin zinc molybdenum vanadium titanium tantalum niobium cr ni mn in sn zn mo v ti ta nb) same plasma near3 (treatment treated treating)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 19:13

S16	27	(BOLED OLED OEL TOLED SOLED FOLED PLED (polymer organic) near2 (EL adj (apparatus device) light lamp luminaire electroluminesc\$9 electro adj luminesc\$9 EL ELD) OELD OED LESD).ab,ti,clm. and plasma near3 (treatment treated treating) with (electrode cathode anode) same (oxygen ozone "O.sub.2" "O.sub.3") and (resistivity resistance) and (tungsten nickel chromium manganese indium tin zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) same plasma near3 (treatment treated treating)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 19:13
S17	39	((BOLED OLED OEL TOLED SOLED FOLED PLED (polymer organic) near2 (EL adj (apparatus device) light lamp luminaire electroluminesc\$9 electro adj luminesc\$9 EL ELD) OELD OED LESD).ab,ti,clm. S3) and plasma near3 (treatment treated treating) with (electrode cathode anode) same (oxygen ozone "O.sub.2" "O.sub.3") and (resistivity resistance) and (tungsten nickel chromium manganese indium tin zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) same plasma near3 (treatment treated treating)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 17:26
S18	3482	(313/504,506).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/08 20:27
S19	38242	((BOLED OLED OEL TOLED SOLED FOLED PLED (polymer organic) near2 (EL adj (apparatus device) light lamp luminaire electroluminesc\$9 electro adj luminesc\$9 EL ELD) OELD OED LESD).ab,ti,clm. S3 S18)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 13:20

S20	40	S19 and plasma near3 (treatment treated treating) with (electrode cathode anode) same (oxygen ozone "O.sub.2" "O.sub.3") and (resistivity resistance) and (tungsten nickel chromium manganese indium tin zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) same plasma near3 (treatment treated treating)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 19:46
S21	88	S19 and plasma near3 (treatment treated treating) with (electrode cathode anode) same (oxygen ozone "O.sub.2" "O.sub.3") and (resistivity resistance) and (tungsten nickel chromium manganese indium tin zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) with (electrode cathod\$2 anod\$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 19:48
S22	39	S19 and plasma near3 (treatment treated treating) with (electrode cathode anode) same (oxygen ozone "O.sub.2" "O.sub.3") and (resistivity resistance) and (tungsten nickel chromium manganese zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) with (electrode cathod\$2 anod\$2) with (semitranspar\$6 semi adj transpar\$6 transpar\$6)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 14:27
S23	3	lyophilic near3 definition	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 20:15
S24	11	lyophilic near3 defined	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 20:15
S25	5519	(313/503-512).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/08 20:27

S26	0	("24notl17").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/08 20:27
S27	1482	S25 not S18	US-PGPUB; USPAT	OR	OFF	2005/06/08 20:27
S28	0	S27 and plasma near3 (treatment treated treating) with (electrode cathode anode) same (oxygen ozone "O.sub.2" "O.sub.3") and (resistivity resistance) and (tungsten nickel chromium manganese zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) with (electrode cathod\$2 anod\$2) with (semitranspar\$6 semi adj transpar\$6 transpar\$6) not S22	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 20:28
S29	0	S27 and plasma near3 (treatment treated treating) with (electrode cathode anode) same (oxygen ozone "O.sub.2" "O.sub.3") and (resistivity resistance) and (tungsten nickel chromium manganese zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) with (electrode cathod\$2 anod\$2) with (semitranspar\$6 semi adj transpar\$6 transpar\$6) not S22	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 20:28
S30	0	S19 and plasma near3 (treatment treated treating) with (electrode cathode anode) same (oxygen ozone "O.sub.2" "O.sub.3") and (resistivity resistance) and (tungsten nickel chromium manganese zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) with (electrode cathod\$2 anod\$2) with (semitranspar\$6 semi adj transpar\$6 transpar\$6) not S22	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/08 20:28
S31	7	(US-20020030441-\$ or US-20020033664-\$ or US-20050023968-\$ or US-20020011205-\$).did. or (US-6853130-\$ or US-6869635-\$ or US-6576352-\$).did.	US-PGPUB; USPAT	OR	OFF	2005/06/09 11:30

S32	7	S31 and plasma	US-PGPUB; USPAT	OR	OFF	2005/06/09 12:32
S33	6	S31 and plasma and (tungsten nickel chromium manganese zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) with (electrode cathod\$2 anod\$2)	US-PGPUB; USPAT	OR	OFF	2005/06/09 11:41
S34	1	"6853130".pn.	US-PGPUB; USPAT	OR	OFF	2005/06/09 11:41
S35	1	S34 and transparent adj electrode	US-PGPUB; USPAT	OR	OFF	2005/06/09 11:45
S36	1	S34 and cathode same transparent	US-PGPUB; USPAT	OR	OFF	2005/06/09 11:43
S37	1	S34 and cathode same reflect\$6	US-PGPUB; USPAT	OR	OFF	2005/06/09 11:44
S38	1	S34 and plasma same anode	US-PGPUB; USPAT	OR	OFF	2005/06/09 12:40
S39	1	S34 and plasma same (cathode electrode anode)	US-PGPUB; USPAT	OR	OFF	2005/06/09 12:29
S40	1	S34 and (resistance resistivity)	US-PGPUB; USPAT	OR	ON	2005/06/09 12:30
S41	1	S34 and transmit\$7	US-PGPUB; USPAT	OR	ON	2005/06/09 12:30
S42	3	S31 and plasma and visible adj region	US-PGPUB; USPAT	OR	OFF	2005/06/09 12:37
S43	5	S31 and plasma and Ni	US-PGPUB; USPAT	OR	OFF	2005/06/09 12:37
S44	0	S38 and (alloy combination)	US-PGPUB; USPAT	OR	OFF	2005/06/09 12:41
S45	1	S38 and (blend\$5 mix mixed mixture highly adj dispersed dispersed knead\$4 admix\$6 scatter\$4)	US-PGPUB; USPAT	OR	ON	2005/06/09 12:42
S46	1	S34 and (blend\$5 mix mixed mixture highly adj dispersed dispersed knead\$4 admix\$6 scatter\$4)	US-PGPUB; USPAT	OR	ON	2005/06/10 12:38
S47	2427	(313/504).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/09 13:21

S48	3509	(313/504,506).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/09 13:21
S49	38288	((BOLED OLED OEL TOLED SOLED FOLED PLED (polymer organic) near2 (EL adj (apparatus device) light lamp luminaire electroluminesc\$9 electro adj luminesc\$9 EL ELD) OELD OED LESD).ab,ti,clm. S47 S48)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 13:21
S50	0	ppv near5 resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 13:21
S51	1	(ppv phenylenevinylene) near5 resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 13:22
S52	5	(ppv phenylenevinylene) with resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 13:23
S53	36	nickel adj oxide near6 resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 13:23
S54	1	"20040189186".did.	US-PGPUB; USPAT	OR	OFF	2005/06/09 13:32
S55	1	S54 and resistivity	US-PGPUB; USPAT	OR	OFF	2005/06/09 13:37
S56	98872	(platinum gold) adj oxide resistivity	US-PGPUB; USPAT	OR	OFF	2005/06/09 13:37
S57	0	(platinum gold) adj oxide near6 resistivity	US-PGPUB; USPAT	OR	OFF	2005/06/09 13:37
S58	34	(platinum gold iridium palladium) adj oxide with ((specific adj resistance) resistivity)	US-PGPUB; USPAT	OR	OFF	2005/06/09 13:38

S59	5	S31 and (blend\$5 mix mixed mixture highly adj dispersed dispersed knead\$4 admix\$6 scatter\$4)	US-PGPUB; USPAT	OR	ON	2005/06/09 14:28
S60	5	S31 and (blend\$5 mix mixed mixture highly adj dispersed dispersed knead\$4 admix\$6 scatter\$4) and (tungsten nickel chromium manganese indium tin zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb)	US-PGPUB; USPAT	OR	ON	2005/06/09 14:29
S61	4	S31 and (blend\$5 mix mixed mixture highly adj dispersed dispersed knead\$4 admix\$6 scatter\$4) and (tungsten nickel chromium manganese indium tin zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) same (electrode cathode anode)	US-PGPUB; USPAT	OR	ON	2005/06/09 14:30
S62	1	S31 and (blend\$5 mix mixed mixture highly adj dispersed dispersed knead\$4 admix\$6 scatter\$4) same (tungsten nickel chromium manganese indium tin zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) same (electrode cathode anode)	US-PGPUB; USPAT	OR	ON	2005/06/09 14:30
S63	1	S31 and (alloy blend\$5 mix mixed mixture highly adj dispersed dispersed knead\$4 admix\$6 scatter\$4) same (tungsten nickel chromium manganese indium tin zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) same (electrode cathode anode)	US-PGPUB; USPAT	OR	ON	2005/06/09 14:31
S64	1	S31 and (alloy blend\$5 mix mixed mixture highly adj dispersed dispersed knead\$4 admix\$6 scatter\$4) same (tungsten nickel chromium manganese indium tin zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) same (electrode cathode anode)	US-PGPUB; USPAT	OR	ON	2005/06/09 14:32

S65	1	S31 and (alloy blend\$5 mix mixed mixture highly adj dispersed dispersed knead\$4 admix\$6 scatter\$4) same (tungsten nickel chromium manganese indium tin zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) same (electrode cathode anode) and plasma	US-PGPUB; USPAT	OR	ON	2005/06/09 14:38
S66	440	S49 and (alloy blend\$5 mix mixed mixture highly adj dispersed dispersed knead\$4 admix\$6 scatter\$4) same (tungsten nickel chromium manganese indium tin zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) same (electrode cathode anode) and plasma near6 (oxygen ozone "O. sub.2" "O.sub.3")	US-PGPUB; USPAT	OR	ON	2005/06/09 14:39
S67	132	S49 and (alloy blend\$5 mix mixed mixture highly adj dispersed dispersed knead\$4 admix\$6 scatter\$4) same (tungsten nickel chromium manganese indium tin zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) same (electrode cathode anode) and plasma near6 (oxygen ozone "O. sub.2" "O.sub.3") with (anode electrode cathode)	US-PGPUB; USPAT	OR	ON	2005/06/09 14:41
S68	84	S49 and (alloy blend\$5 mix mixed mixture highly adj dispersed dispersed knead\$4 admix\$6 scatter\$4) same (tungsten nickel chromium manganese indium tin zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) same (electrode cathode anode) and plasma near6 (oxygen ozone "O. sub.2" "O.sub.3") near6 (treatment treat treating treated) with (anode electrode cathode)	US-PGPUB; USPAT	OR	ON	2005/06/09 14:47
S69	2	"6713781".pn.	US-PGPUB; USPAT; DERWENT	OR	ON	2005/06/09 15:15
S70	1	2004-326636.NRAN.	DERWENT	OR	OFF	2005/06/09 14:47
S71	2	"6885147".pn.	US-PGPUB; USPAT; DERWENT	OR	ON	2005/06/09 15:15

S72	1	S71 and plasma	US-PGPUB; USPAT; DERWENT	OR	ON	2005/06/09 15:21
S73	2	"20010051487".did. and plasma	US-PGPUB; USPAT; DERWENT	OR	ON	2005/06/09 15:22
S74	1	"6869635".pn.	US-PGPUB; USPAT	OR	OFF	2005/06/09 15:58
S75	13329	cathode with (material formed made) and plasma	US-PGPUB; USPAT	OR	OFF	2005/06/09 15:59
S76	13329	"1" and cathode with (material formed made) and plasma	US-PGPUB; USPAT	OR	OFF	2005/06/09 15:59
S77	1	S74 and cathode with (material formed made) and plasma	US-PGPUB; USPAT	OR	OFF	2005/06/09 16:07
S78	149	aluminum adj oxide near6 resistivity	US-PGPUB; USPAT	OR	OFF	2005/06/09 16:13
S79	39	(Mori near2 Toshitaka Oyagi near2 Yasuyuki Kido near2 Junji).in.	US-PGPUB; USPAT	OR	ON	2005/06/09 16:13
S80	1	S79 and plasma.clm.	US-PGPUB; USPAT	OR	ON	2005/06/09 16:14
S81	6	S79 and injection.clm.	US-PGPUB; USPAT	OR	ON	2005/06/09 17:23
S82	1	"6835130".pn.	US-PGPUB; USPAT	OR	ON	2005/06/09 17:23
S83	1	"6853130".pn.	US-PGPUB; USPAT	OR	ON	2005/06/09 17:23
S84	2	"6853130".pn.	US-PGPUB; USPAT; DERWENT	OR	ON	2005/06/09 17:25
S85	1	2002-414660.NRAN.	DERWENT	OR	OFF	2005/06/09 17:23
S86	954	(313/503).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/09 17:25
S87	23	S86 and (oxygen ozone "O.sub.2" "O.sub.3") near6 plasma near3 (treatment treated treating)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 17:51

S88	27	(US-20010051487-\$ or US-20020011205-\$ or US-20020030441-\$ or US-20020033664-\$ or US-20020039730-\$ or US-20020160553-\$ or US-20030039858-\$ or US-20030062826-\$ or US-20030137242-\$ or US-20030146695-\$ or US-20030197466-\$ or US-20040082250-\$ or US-20040232830-\$ or US-20050023968-\$ or US-20050057136-\$ or US-20050057151-\$ or US-20020021088-\$).did. or (US-6576352-\$ or US-6626722-\$ or US-6764777-\$ or US-6853130-\$ or US-6869635-\$ or US-6303494-\$ or US-6060826-\$ or US-6768258-\$ or US-6853134-\$ or US-6885147-\$).did.	US-PGPUB; USPAT	OR	OFF	2005/06/09 17:26
S89	19	S87 not S88	US-PGPUB; USPAT	OR	OFF	2005/06/09 17:34
S90	5	S87 and oxidiz\$6 not S88	US-PGPUB; USPAT	OR	OFF	2005/06/09 17:49
S91	4729	((257/40) or (362/800) or (315/169.3)).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/06/09 17:51
S92	69	S91 and (oxygen ozone "O.sub.2" "O.sub.3") near6 plasma near3 (treatment treated treating)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 17:51
S93	2427	(313/504).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/09 17:51
S94	3509	(313/504,506).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/09 17:51

S95	38288	((BOLED OLED OEL TOLED SOLED FOLED PLED (polymer organic) near2 (EL adj (apparatus device) light lamp luminaire electroluminesc\$9 electro adj luminesc\$9 EL ELD) OELD OED LESD).ab,ti,clm. S93 S94)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 17:51
S96	84	S95 and (alloy blend\$5 mix mixed mixture highly adj dispersed dispersed knead\$4 admix\$6 scatter\$4) same (tungsten nickel chromium manganese indium tin zinc molybdenum vanadium titanium tantalum niobium cr ni mn sn zn mo v ti ta nb) same (electrode cathode anode) and plasma near6 (oxygen ozone "O.sub.2" "O.sub.3") near6 (treatment treat treating treated) with (anode electrode cathode)	US-PGPUB; USPAT	OR	ON	2005/06/09 17:51
S97	60	S91 and (oxygen ozone "O.sub.2" "O.sub.3") near6 plasma near3 (treatment treated treating) not S96	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 17:53
S98	8	S91 and (electrode cathode anode) with (oxygen ozone "O.sub.2" "O.sub.3") near6 plasma near3 (treatment treated treating) not S96	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 18:27
S99	264	hirano near2 takayuki.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 18:28
S100	1	S99 and negative adj electrode near3 K	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 18:28
S101	7	S99 and negative adj electrode	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 18:28

S10 2	283114	sony.as.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 18:29
S10 3	6	S102 and negative adj electrode near5 K	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 18:30
S10 4	6	S99 and 3c	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 18:30
S10 5	264	hirano near2 takayuki.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 18:49
S10 6	0	S105 and chromium adj oxide	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 18:59
S10 7	2	"2002216976"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 19:48
S10 8	4	"2001043980"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 19:18
S10 9	2	"6831408".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 19:48

S11 0	1	S109 and oxide	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 20:06
S11 1	2	"6774561".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/09 20:09
S11 2	1	2002-500914.NRAN.	DERWENT	OR	OFF	2005/06/09 20:06
S11 3	1	"6774561".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:14
S11 4	0	S113 and plasma	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:16
S11 5	1	S113 and reflectivity	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:18
S11 6	1	"6831408".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:22
S11 7	0	Alq3 near5 resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:22
S11 8	0	Alq3 with resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:24
S11 9	0	quinolinol near2 aluminum with resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:23

S12 0	121899	resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:23
S12 1	5	quinolinol near2 aluminum with conductivity	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:50
S12 2	0	"ALq3" with resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:25
S12 3	20	"ALq3" with (conductivity electroconductivity)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:24
S12 4	0	"ALq3" with (specific adj resistance)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:25
S12 5	0	quinolinol near2 aluminum with (specific adj resistance)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:37
S12 6	0	quinolinol near3 aluminum with (resistivity)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:37
S12 7	0	quinolinol near4 aluminum with (resistivity)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:37
S12 8	0	quinolinol near4 (al aluminum) with (resistivity)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:39
S12 9	1	Alq with (resistivity)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:39

S13 0	0	quinolinol with (resistivity specific adj resistance)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:50
S13 1	1009	Alq3	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:51
S13 2	0	aluminum near4 quinolinolato with resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:51
S13 3	0	quinolinolato with resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/10 11:43
S13 4	2	quinolinolato with conductivity	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:52
S13 5	3	"AIQ.sub.3" with resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 20:53
S13 6	18	"AIQ.sub.3" same resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 21:04
S13 7	1	"6831408".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/10 12:26
S13 8	1	S137 and alloy	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 21:05
S13 9	1	S137 and dual	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/06/09 21:05

S14 0	104	chromium adj oxide with resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 11:23
S14 1	8	"Cr.sub.2O.sub.3" with resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 11:34
S14 2	10	"Alq.sub.3" with (conductivity resistivity)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 11:31
S14 3	25	hydroxyquinoline with (conductivity resistivity)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 11:31
S14 4	5	hydroxyquinoline near4 (aluminum al) with (conductivity resistivity)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 11:32
S14 5	13	"CrO.sub.2" with resistivity	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/10 11:41